Photocouplers Photorelay

TLP240GA,TLP240GAF

1. Applications

- Mechanical relay replacements
- Security Systems
- Measuring Instruments
- Factory Automation (FA)
- Amusement Equipment
- Smart Meters
- Electricity Meters

2. General

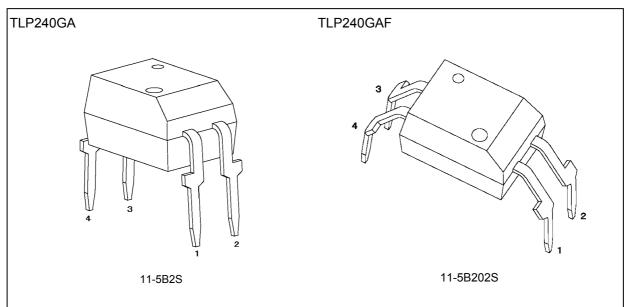
The TLP240GA and TLP240GAF photorelay consist of a photo MOSFET optically coupled to an infrared light emitting diode. They are housed in a 4-pin DIP package. They provide an isolation voltage of 5000 Vrms, making them suitable for applications that require reinforced insulation.

3. Features

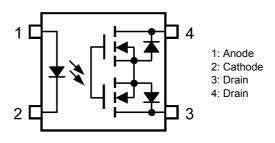
- (1) Normally opened (1-Form-A)
- (2) OFF-state output terminal voltage: 400 V (min)
- (3) Trigger LED current: 3 mA (max)
- (4) ON-state current: 120 mA (max)
- (5) ON-state resistance: 28Ω (max, t < 1s)
 - $35 \ \Omega$ (max, Continuous)
- (6) Isolation voltage: 5000 Vrms (min)
- (7) Safety standards
 - UL-under application: UL1577 File No. E67349

cUL-under application: CSA Component Acceptance Service No. 5A, File No. E67349 VDE-under application: EN60747-5-5

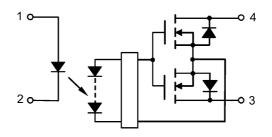
4. Packaging



5. Pin Assignment



6. Internal Circuit



7. Mechanical Parameters

Characteristics	7.62-mm Pitch TLP240GA	10.16-mm Pitch TLP240GAF	Unit
Creepage distances	7.0 (min)	8.0 (min)	mm
Clearance distances	7.0 (min)	8.0 (min)	
Internal isolation thickness	0.4 (min)	0.4 (min)	

8. Absolute Maximum Ratings (Note) (Unless otherwise specified, T_a = 25 °C)

	Characteristics	3	Symbol	Note	Rating	Unit
LED	Input forward current		I _F		30	mA
	Input forward current derating	$(T_a \ge 25 \ ^\circ C)$	$\Delta I_F / \Delta T_a$		-0.3	mA/°C
	Input forward current (pulsed)	(100 μs pulse, 100 pps)	I _{FP}		1	A
	Input reverse voltage		V _R		5	V
	Input power dissipation		PD		50	mW
	Junction temperature		Тj		125	°C
Detector	OFF-state output terminal voltage		V _{OFF}		400	V
	ON-state current		I _{ON}		120	mA
	ON-state current derating	$(T_a \ge 25 \ ^{\circ}C)$	$\Delta I_{ON} / \Delta T_a$		-1.2	mA/°C
	ON-state current (pulsed)	(t = 100 ms, Duty = 1/10)	I _{ONP}		360	mA
	Output power dissipation		Po		500	mW
	Junction temperature		Tj		125	°C
Common	Storage temperature		T _{stg}		-55 to 125	
	Operating temperature		T _{opr}		-40 to 85	
	Lead soldering temperature	(10 s)	T _{sol}		260	
	Isolation voltage	AC, 1 min, R.H. \leq 60 %	BVS	(Note 1)	5000	Vrms

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 1: This device is considered as a two-terminal device: Pins 1 and 2 are shorted together, and pins 3 and 4 are shorted together.

9. Recommended Operating Conditions (Note)

Characteristics	Symbol	Note	Min	Тур.	Max	Unit
Supply voltage	V _{DD}		_	_	320	V
Input forward current	١ _F		5	7.5	25	mA
ON-state current	I _{ON}		_	_	120	
Operating temperature	T _{opr}		-20	_	65	°C

Note: The recommended operating conditions are given as a design guide necessary to obtain the intended performance of the device. Each parameter is an independent value. When creating a system design using this device, the electrical characteristics specified in this datasheet should also be considered.

10. Electrical Characteristics (Unless otherwise specified, T_a = 25 °C)

	Characteristics	Symbol	Note	Test Condition	Min	Тур.	Max	Unit
LED	Input forward voltage	V _F		I _F = 10 mA	1.1	1.27	1.4	V
	Input reverse current	I _R		V _R = 5 V			10	μA
	Input capacitance	Ct		V = 0 V, f = 1 MHz	_	50	_	pF
Detector	OFF-state current	I _{OFF}		V _{OFF} = 400V	_	_	1000	nA
	Output capacitance	C _{OFF}		V = 0 V, f = 1 MHz		80		pF

11. Coupled Electrical Characteristics (Unless otherwise specified, T_a = 25 °C)

Characteristics	Symbol	Note	Test Condition	Min	Тур.	Max	Unit
Trigger LED current	I _{FT}		I _{ON} = 120 mA	_	0.6	3	mA
Return LED current	I _{FC}		I _{OFF} = 10 μA	0.1	_	_	
ON-state resistance	R _{ON}		I _{ON} = 120 mA, I _F = 5 mA, t < 1s	_	17	28	Ω
		(Note 1)	I_{ON} = 120 mA, I_F = 5 mA, Continuous		22	35	

Note 1: Thermally saturated state.

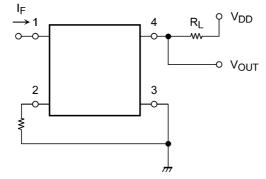
12. Isolation Characteristics (Unless otherwise specified, $T_a = 25$ °C)

Characteristics	Symbol	Note	Test Condition	Min	Тур.	Max	Unit
Total capacitance (input to output)	Cs	(Note 1)	V _S = 0 V, f = 1 MHz	_	0.8	—	pF
Isolation resistance	R _S	(Note 1)	V_S = 500 V, R.H. \leq 60 %	1×10^{12}	10 ¹⁴	—	Ω
Isolation voltage	BVS	(Note 1)	AC, 1 min	5000	_		Vrms
			AC, 1s in oil	_	10000	_	
			DC, 1 min, in oil	_	10000	_	Vdc

Note 1: This device is considered as a two-terminal device: Pins 1 and 2 are shorted together, and pins 3 and 4 are shorted together.

13. Switching Characteristics (Unless otherwise specified, Ta = 25 °C)

Characteristics	Symbol	Note	Test Condition	Min	Тур.	Max	Unit
Turn-on time	t _{ON}		See Fig. 13.1.		0.6	2	ms
Turn-off time	t _{OFF}		R_{L} = 200 Ω, V_{DD} = 20 V, I_{F} = 5 mA	_	0.2	1	



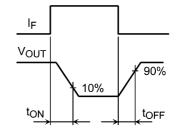
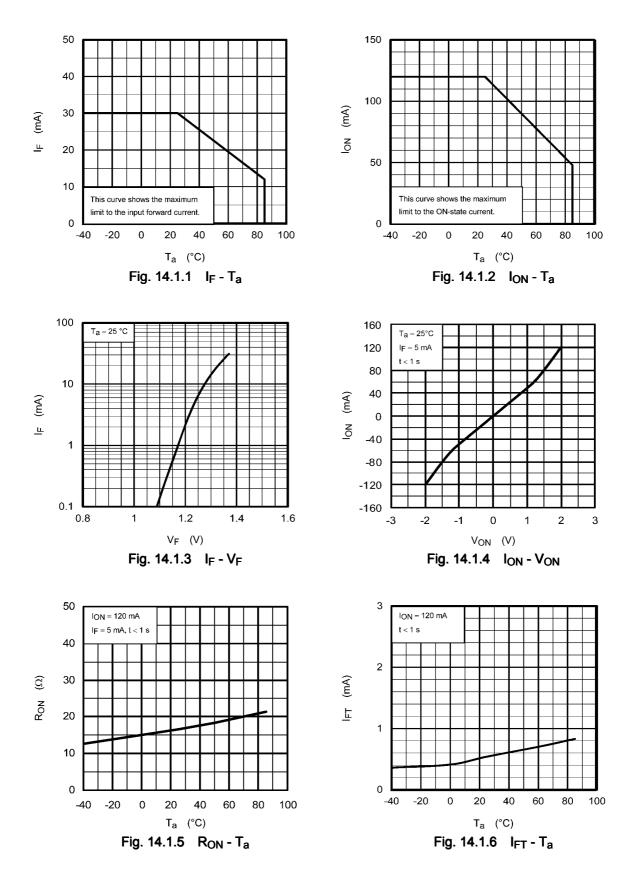
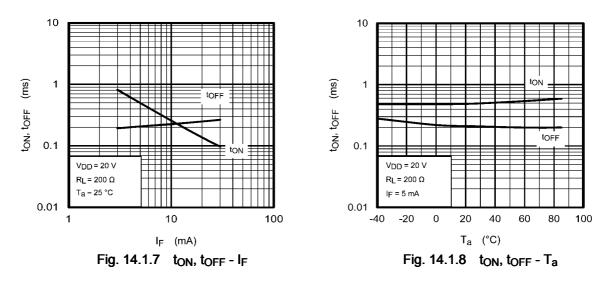


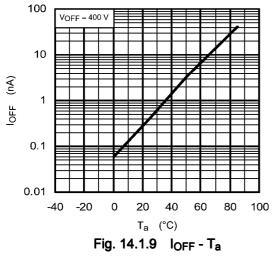
Fig. 13.1 Switching Time Test Circuit

14. Characteristics Curves

14.1. Characteristics Curves (Note)





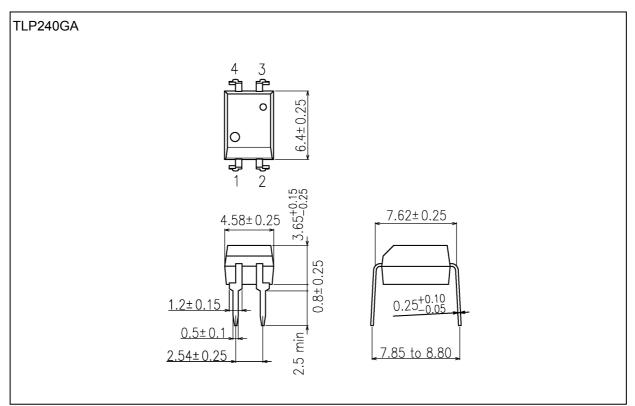


Note: The above characteristics curves are presented for reference only and not guaranteed by production test, unless otherwise noted.



Package Dimensions

Unit: mm



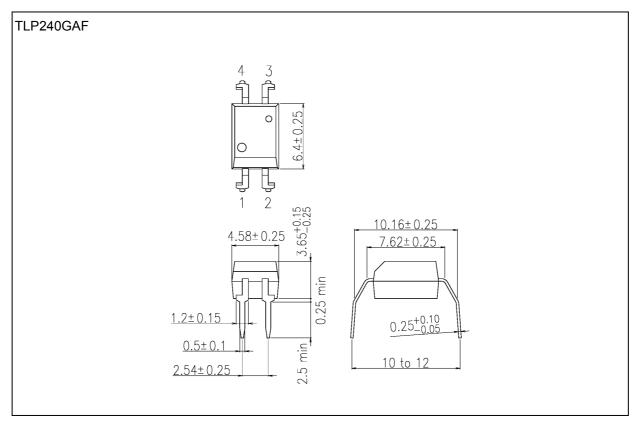
Weight: 0.26 g (typ.)

	Package Name(s)
TOSHIBA: 11-5B2S	



Package Dimensions

Unit: mm



Weight: 0.26 g (typ.)

	Package Name(s)
TOSHIBA: 11-5B202S	

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